



PRODUCT DATA SHEET



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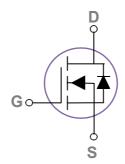


General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOT-23 Pin	Configuration
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BVDSS	RDSON	ID
60V	75mΩ	3A

Features

- 60V, 3A, $RDS(ON) = 75m\Omega@VGS = 10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

Applications

- Motor Drive
- Power Tools
- LED Lighting

Absolute Maximum Ratings Tc=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Sou₁ce Voltage	±20	V
1	Drain Current – Continuous (T _C =25℃)	3.0	Α
I _D	Drain Current – Continuous (T _C =100°C)	2	Α
I _{DM}	Drain Current – Pulsed ¹	12.0	А
D	Power Dissipation (T _C =25°C)	1.56	W
P _D	Power Dissipation – Derate above 25℃	0.012	W/∘c
T _{STG}	Storage Temperature Range	-50 to 150	
TJ	Operating Junction Temperature Range	-50 to 125	°C

Thermal Characteristics

Symbol	pol Parameter		Max.	Unit
R _{θJA}	R _{BJA} Thermal Resistance Junction to ambient		80	°C/W



Electrical Characteristics (T_J=25 ℃, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA				V
△BV _{DSS} /△T _J	BV _{DSS} Temperature Coefficient	Reference to 25℃, I _D =1mA		0.05		V/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =60V , V _{GS} =0V , T _J =25℃			1	uA
		V _{DS} =48V , V _{GS} =0V , T _J =125℃			10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA

On Characteristics

R _{DS(ON)} Static Drain-Source On-Resistance	Static Drain Source On Resistance	V_{GS} =10V , I_D =3A		75	95	mΩ
	V _{GS} =4.5V , I _D =2A		85	110	mΩ	
$V_{GS(th)}$	Gate Threshold Voltage	-V _{GS} =V _{DS} , I _D =250uA	1.0	1.6	2.5	V
${}^{\triangle}V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS, ID -250UA		-5		mV/∘c
gfs	Forward Transconductance	V _{DS} =10V , I _D =3A		7		S

Dynamic and switching Characteristics

Qg	Total Gate Charge ^{2,3}		 9.3	
Q_{gs}	Gate-Source Charge ^{2, 3}	V_{DS} =48V , V_{GS} =10V , I_{D} =3A	 2.1	 nC
Q_{gd}	Gate-Drain Charge ^{2, 3}		 1.8	
$T_{d(on)}$	Turn-On Delay Time ^{2, 3}		 2.9	
Tr	Rise Time ^{2, 3}	V_{DD} =30V , V_{GS} =10V , R_{G} =3.3 Ω	 9.5	 no
$T_{d(off)}$	Turn-Off Delay Time ^{2, 3}	I _D =1A	 18.4	 ns
T _f	Fall Time ^{2, 3}		 5.3	
C _{iss}	Input Capacitance		 500	
Coss	Output Capacitance	V_{DS} =15V , V_{GS} =0V , F=1MHz	 45	 pF
C _{rss}	Reverse Transfer Capacitance		 16	
R_g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	 2	 Ω

Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current	V _G =V _D =0V . Force Current			3.0	Α
I _{SM}	Pulsed Source Current	VG-VD-UV , FOICE Current			6.0	Α
V_{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =1A , T _J =25℃			1.2	V

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- The data tested by pulsed , pulse width $\le 300 us$, duty cycle $\le 2\%.$ Essentially independent of operating temperature.



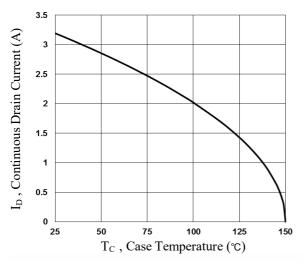


Fig.1 Continuous Drain Current vs. T_c

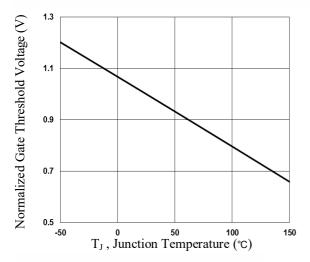


Fig.3 Normalized V_{th} vs. T_J

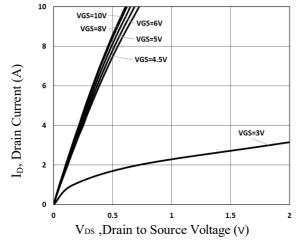


Fig.5 Typical Output Characteristics

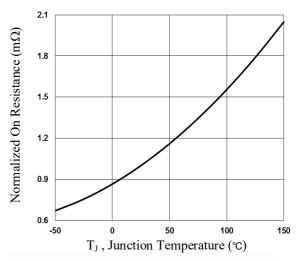


Fig.2 Normalized RDSON vs. T,

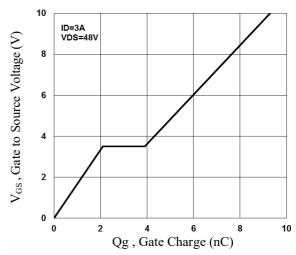


Fig.4 Gate Charge Waveform

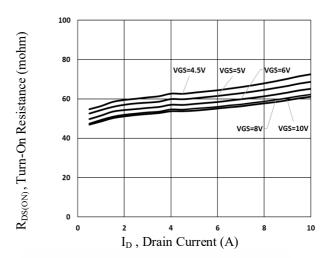


Fig.6 Turn-On Resistance vs. ID

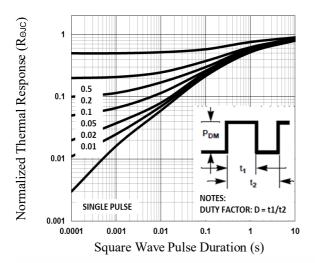


Fig.7 Normalized Transient Response

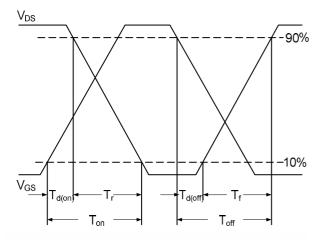


Fig.9 Switching Time Waveform

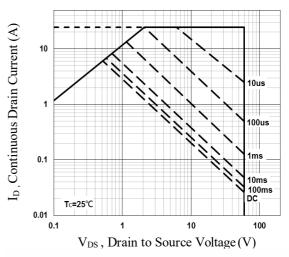
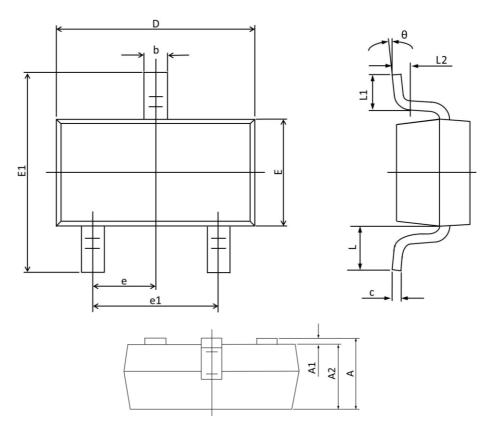


Fig.8 Maximum Safe Operation Area



SOT-23 PACKAGE INFORMATION



Crymbal	Dimensions I	n Millimeters	Dimension	ns In Inches
Symbol	Max	Min	Max	Min
A	1.150	0.900	0.045	0.035
A1	0.100	0.000	0.004	0.000
A2	1.050	0.900	0.041	0.035
b	0.500	0.300	0.020	0.012
c	0.150	0.080	0.006	0.003
D	3.000	2.800	0.118	0.110
E	1.400	1.200	0.055	0.047
E 1	2.550	2.250	0.100	0.089
e	0.95	TYP.	0.037 TYP.	
e1	2.000	1.800	0.079	0.071
L	0.55 REF.		0.02	2 REF.
L1	0.500	0.300	0.020	0.012
L2	0.25 TYP.		0.01	TYP.
θ	8°	0°	8°	0°



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